

# **KBU6A - KBU6M**

### **Features**

- High surge current capability.
- Reliable construction technique.
- Ideal for printed circuit board.



# **Bridge Rectifiers**

### **Absolute Maximum Ratings\*** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value						Units	
		6A	6B	6D	6G	6J	6K	6M	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
$V_R$	DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Rectified Forward Current, @ $T_A = 65$ °C  6.0			Α					
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current 250			Α					
T <sub>stg</sub>	Storage Temperature Range -55 to +150			°C					
T <sub>J</sub>	Operating Junction Temperature -55 to +150			°C					

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$P_{D}$	Power Dissipation	6.7	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,* per leg	8.6	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead,* per leg	4.0	°C/W

<sup>\*</sup>Device mounted on PCB with 0.375 " (9.5 mm) lead length and 0.5 x 0.5" (12 x 12 mm) copper pads.

### **Electrical Characteristics** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Device	Units
V <sub>F</sub>	Forward Voltage, per bridge @ 6.0 A	1.0	V
I <sub>R</sub>	Reverse Current, total bridge @ rated $V_R$ $T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$	5.0 500	μΑ μΑ

## **Bridge Rectifiers**

(continued)

### **Typical Characteristics**

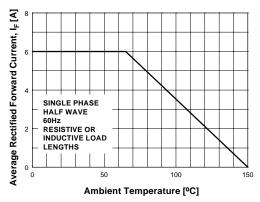


Figure 1. Forward Current Derating Curve

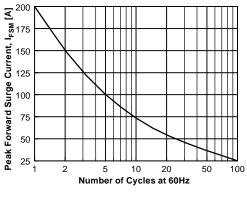


Figure 2. Non-Repetitive Surge Current

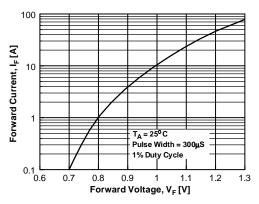


Figure 3. Forward Voltage Characteristics

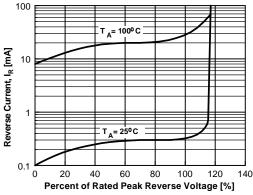


Figure 4. Reverse Current vs Reverse Voltage

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